14. The electronic device of claim **13**, wherein the one or more lateral edges of the transparent support substrate are tapered.

15. The electronic device of claim **4**, further comprising a polymer adhesion layer between the hardcoat layer and the transparent support substrate.

16. The electronic device of claim **15**, wherein the polymer adhesion layer is 1-10 μm thick.

17. The electronic device of claim **4**, further comprising a glass fiber mesh between the hardcoat layer and the transparent support substrate.

18. The electronic device of claim **4**, wherein the hardcoat layer is formed around lateral edges of the transparent support substrate.

19. The electronic device of claim **4**, wherein the transparent support substrate is formed of a material selected from the group consisting of glass and sapphire.

20. The electronic device of claim **4**, further comprising a smudge resistant coating on an exterior facing coating of the hardcoat layer.

21. An electronic device comprising:

a flexible display panel; and

a protective cover layer over the display panel, wherein the protective cover layer flexes with the flexible display panel and includes a transparent support substrate and a hardcoat layer covering an exterior facing surface of the transparent support substrate; and

a housing to contain the flexible display panel and the protective cover layer.

22. The electronic device of claim **21**, wherein the flexible display panel is foldable, and the protective cover layer folds with the foldable display panel.

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